

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s
1	BRS	1	etching same (defect or dangling) same (amorphous adj2 hydrogen\$4 adj2 silicon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 10:24		0
2	BRS	26	etching same (amorphous adj2 hydrogen\$4 adj2 silicon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 12:54		0
3	BRS	15758	etching same (SiO2 or "lattice damage" or "silicon dioxide" or dangling)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 12:56		0
4	BRS	6209	(etching same (SiO2 or "lattice damage" or "silicon dioxide" or dangling)) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 12:56		0
5	BRS	3522	etching same (SiO2 or "lattice damage" or "silicon dioxide" or dangling) same plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 12:56		0
6	BRS	1605	(etching same (SiO2 or "lattice damage" or "silicon dioxide" or dangling) same plasma) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 13:06		0
7	BRS	15	etching same (SiO2 and "lattice damage" or "silicon dioxide" and dangling) same plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 12:58		0
8	BRS	101	etching same ( "lattice damage" or "surface defect" or dangling) same plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 13:00		0

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r m e s s a g e s	E r r o r s
9	BRS	63	(etching same ( "lattice damage" or "surface defect" or dangling) same plasma) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 13:00			0
10	BRS	1061	((etching same (SiO2 or "lattice damage" or "silicon dioxide" or dangling) same plasma) and 438/\$.ccls.) and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 13:08			0
11	BRS	23	"5306671"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 15:51			0
12	BRS	192	"wet etching" same (thickness) same (etch\$3 adj rate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 16:59			0
13	BRS	60	((("wet etching" same (thickness) same (etch\$3 adj rate)) and 438/\$.ccls.) and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:51			0
14	BRS	1	"wet etching" same (thickness) same (etch\$3 adj rate) same (parameter or variable)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:01			0
15	BRS	57	etching same (thickness) same (etch\$3 adj rate) same (parameter or variable)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:18			0
16	BRS	97	("wet etching" same (thickness) same (etch\$3 adj rate)) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:49			0

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r D e f i n i t i o n	E r r o r s
17	BRS	87	(thickness) same (etch\$3 adj (rate or selectivity)) same (parameter or variable)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:06			0
18	BRS	38	( (thickness) same (etch\$3 adj (rate or selectivity)) same (parameter or variable)) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:30			0
19	BRS	9	"4199337"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:16			0
20	BRS	8	(etching adj (parameter or variable)) same (thickness)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:21			0
21	BRS	17	(process\$3 adj (parameter or variable)) same (thickness) same etching	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:24			0
22	BRS	360	(adjust\$3 or vary\$3) same (thickness) same (etch\$3 adj rate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:30			0
23	BRS	158	((adjust\$3 or vary\$3) same (thickness) same (etch\$3 adj rate)) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:30			0
24	BRS	95	((adjust\$3 or vary\$3) same (thickness) same (etch\$3 adj rate)) and 438/\$.ccls.) and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:45			0

	Type	Hits	Search Text	DBs	Time Stamp	Com ment s	Er or D ef in iti on	Er ro rs
25	BRS	7512	(etch\$ adj (depth or thickness))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:47		Tr un c ati on o v er flo w.	1
26	BRS	7378	(etch or etched or etching) adj (depth or thickness)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:50			0
27	BRS	2501	((etch or etched or etching) adj (depth or thickness)) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:51			0
28	BRS	1575	((etch or etched or etching) adj (depth or thickness)) and 438/\$.ccls.) and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:50			0
29	BRS	823	(etch or etched or etching) adj (depth or thickness) same (etch\$3 adj (rate or selectivity))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:51			0
30	BRS	354	((etch or etched or etching) adj (depth or thickness) same (etch\$3 adj (rate or selectivity))) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:51			0
31	BRS	205	((etch or etched or etching) adj (depth or thickness) same (etch\$3 adj (rate or selectivity))) and 438/\$.ccls.) and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/28 17:52			0

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r D e f i n i t i o n	E r r o r s
32	BRS	25716	etching same ((thickness or depth) near5 layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 08:56			0
33	BRS	154	etching same "dangling bonds"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 09:27			0
34	BRS	85	(etching same "dangling bonds") and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 08:57			0
35	BRS	48	((etching same "dangling bonds") and 438/\$.ccls.) and @pd<=19991116	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 08:58			0
36	BRS	28	etching near5 "dangling bonds"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 10:04			0
37	BRS	3	"wet etching" near5 "dangling bonds"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 10:08			0
38	BRS	5	((dry or plasma) adj etching) near5 "dangling bonds"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 10:10			0
39	BRS	8	((dry or plasma) adj etching) near10 "dangling bonds"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 10:14			0

	Type	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r m e s s a g e s	E r r o r s
40	BRS	3	((dry or plasma) adj etching) near10 "dangling bonds") NOT ((dry or plasma) adj etching) near5 "dangling bonds")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 10:11			0
41	BRS	15	((dry or plasma) adj etching) near20 "dangling bonds"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 10:14			0
42	BRS	7	((dry or plasma) adj etching) near20 "dangling bonds") NOT ((dry or plasma) adj etching) near10 "dangling bonds")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 10:15			0
43	IS&R	6	(("4996082") or ("4579760")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/05/29 18:28			0